

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: A1110-03 DATE: May 28, 2012		MEANS OF DISTINGUISHING CHANGED DEVICES:				
Product Affected: All SFC Products (Refer to Attachment II)		☐ Product Mark ☐ Back Mark ☐ Date Code	location is maintained	ckmetal & backgrinding by IDT and available		
Date Effective: August 28, 2012		Other	on request			
Contact: Mary Vesey		Au 1	- 37			
Title: Director, Product Assurance	e	Attachment:	Yes	∐ No		
Phone #: (408) 284-4565						
` '	(408) 284-1450 Samples: Availability shown on request					
E-mail: <u>Mary.Vesey@idt.com</u>						
DESCRIPTION AND PURPOSE OF CHA	NGE:					
☐ Die Technology	to inform our customers of the backmetal and backgrinding					
☐ Wafer Fabrication Process	location changes as	follows:				
☐ Assembly Process						
☐ Equipment	1. Backmetal location changed from UHV to UAT					
☐ Material						
☐ Testing - Test Site ☐ Manufacturing Site	Attachment I details the change and					
□ Data Sheet Attachment II lists the affected part numbers ■ Other - Backmetal & Backgrinding Location						
RELIABILITY/QUALIFICATION SUMMARY: There is no expected change to the product quality or reliability performance.						
CUSTOMER ACKNOWLEDGMENT OF RECEIPT: IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date.						
Customer:			hipments prior to	effective date.		
Name/Date:	E-N	Mail Address:				
Title:	Phone# /Fax# :					
CUSTOMER COMMENTS:						
IDT ACKNOWLEDGMENT OF RECEIP	T:					
RECD. BY:		DATE:		_		

IDT FRA-1509-01 REV. 01 06/22/09

REFER TO QCA-1795



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ATTACHMENT I - PCN # : A1110-03

PCN Type: Change of Backmetal & Backgrinding Location

Data Sheet Change: No Change

Details Of Change:

This notification is to inform our customers of the backmetal and backgrinding location changes as follows:

1. Backmetal location changed from UHV to UAT

2. Backgrinding location changed from GDSI to Unisem Ipoh

Attachment I details the change and Attachment II lists the affected part numbers

This change will provide the increased capacity and shorter lead time to meet market demand.

Qualification Test Plans and Results:

Qualification Plan #: SF110901

Test Vehicle: 8102 (3 lots)

Test Description	Test Method (Latest specs in effect)	Test Results (SS / Rej)
Temperature Cycle (-55 °C to +125 °C, 700 Cycles)	JESD22-A104	45/0, 45/0, 45/0

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ATTACHMENT II - PCN #: A1110-03

Affected Part Number

Part Number	Part Number	Part Number	Part Number
8102-22.57VPCNVG	8102-48VPCNVGT	8202-12VPC-C	8202-13VPCNSG
8102-24.576VPCNVG	8102-50VPCNVG	8202-12VPC-D	8203-24VPCNSGIT
8102-25VPCNSG	8102-6VPCNSG	8202-12VPCNVG	8203-48VPC-D